Onsemi

MOSFET – Power, N-Channel, **SMPS**

V _{DS}	R _{DS(ON)} MAX	I _D MAX
500 V	120 mΩ @ 10 V	44 A

500 V, 44 A, 120 mΩ

FDH44N50

Description

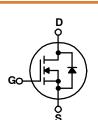
UniFET[™] MOSFET is onsemi's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

Features

- Low Gate Charge Q_g Results in Simple Drive Requirement (Typ. 90 nC)
- Improved Gate, Avalanche and High Reapplied dv/dt Ruggedness
- Reduced $R_{DS(on)}$ (110 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 22 A)
- Reduced Miller Capacitance and Low Input Capacitance (Typ. $C_{rss} = 40 \text{ pF}$)
- Improved Switching Speed with Low EMI
- 175°C Rated Junction Temperature
- · This Device is Pb-Free and is RoHS Compliant

Applications

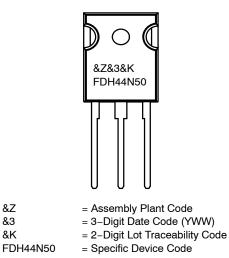
- Lighting
- Uninterruptible Power Supply
- AC–DC Power Supply





TO-247-3LD CASE 340CK

MARKING DIAGRAM



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ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	FDH44N50	Unit
V _{DSS}	Drain to Source Voltage	500	V
V_{GS}	Gate-Source Voltage	±30	V
I _D	$\label{eq:continuous} \begin{array}{llllllllllllllllllllllllllllllllllll$		A
PD	Power Dissipation	750	W
	Derate Above 25°C	5	W/°C
T _J , T _{STG}	Operating and Storage Temperature	–55 to + 175	°C
	Soldering Temperature for 10 Seconds	300 (1.6 mm from Case)	°C
	Mounting Torque, 8–32 or M3 Screw	10 ibf*in (1.1 N*m)	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FDH44N50	FDH44N50	TO-247-3	Tube	N/A	N/A	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	FDH44N50	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.2	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition		Min.	Тур.	Max.	Unit
STATICS	•	-		-	-	-	-
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$		500	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{/\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C		-	0.61	_	V/°C
r _{DS(ON)}	Drain to Source On-Resistance	V_{GS} = 10 V, I _D = 22 A		-	0.11	0.12	Ω
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D =$	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3.15	4	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V	$T_{C} = 25^{\circ}C$	-	-	25	μΑ
		V _{GS} = 0 V	T _C = 150°C	-	-	250	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V$		-	-	±100	nA
DYNAMICS							
gf _S	Forward Transconductance	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 22 \text{ A}$		11	-	-	S
Q _{g(TOT)}	Total Gate Charge at 10 V	V _{GS} = 10 V, V _D	_S = 400 V, I _D = 44 A	-	90	108	nC

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Q _{g(TOT)}	Total Gate Charge at 10 V	V_{GS} = 10 V, V_{DS} = 400 V, I_D = 44 A	-	90	108	nC
Q _{gs}	Gate to Source Gate Charge		-	24	29	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	31	37	nC
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 44 \text{ A},$	-	16	-	ns
t _r	Turn-On Rise Time	R_D = 5.68 Ω, R_G = 2.15 Ω	-	84	-	ns
t _{d(off)}	Turn-Off Delay Time		-	45	-	ns
t _f	Turn-Off Fall Time		-	79	-	ns
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	-	5335	-	pF
C _{oss}	Output Capacitance		-	645	-	pF
C _{rss}	Reverse Transfer Capacitance		-	40	_	pF

AVALANCHE CHARACTERISTICS

E _{AS}	Single Pulse Avalanche Energy (Note 2)	1500	-	-	mJ
I _{AR}	Avalanche Current	-	-	44	А

DRAIN-SOURCE DIODE CHARACTERISTICS

I _S	Continuous Source Current (Body Diode)	MOSFET symbol Showing the integral	-	-	44	A
I _{SM}	Pulsed Source Current (Body Diode) (Note 1)	reverse p-n junction diode.	-	-	176	A
V _{SD}	Source to Drain Diode Voltage	I _{SD} = 44 A	-	0.900	1.2	V
t _{rr}	Reverse Recovery Time	I_{SD} = 44 A, d I_{SD} /dt = 100 A/µs	-	920	1100	ns
Q _{rr}	Reverse Recovery Charge	I_{SD} = 44 A, dI _{SD} /dt = 100 A/µs	-	14	18	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Starting $T_J = 25^{\circ}$ C, L = 1.61 mH, I_{AS} = 44 A

TYPICAL CHARACTERISTICS

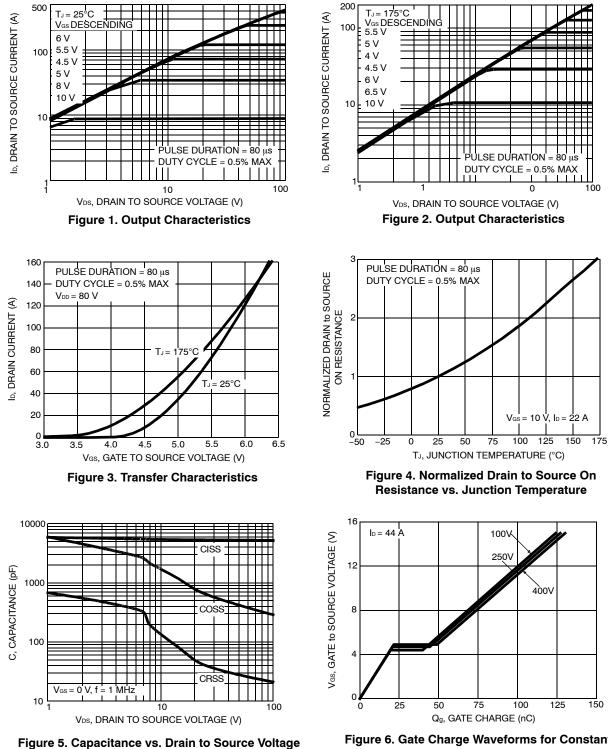
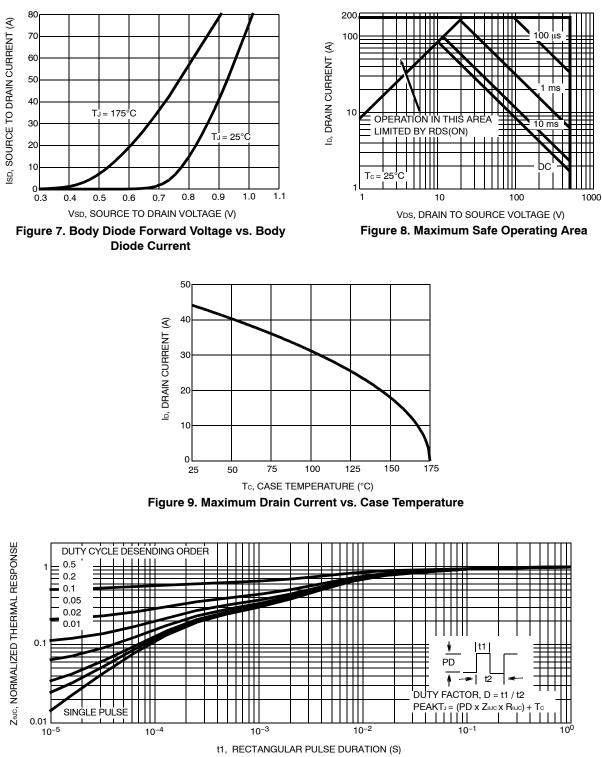


Figure 6. Gate Charge Waveforms for Constant **Gate Current**

TYPICAL CHARACTERISTICS





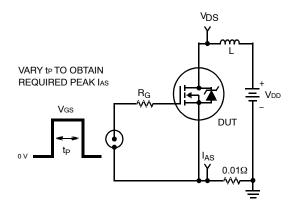


Figure 11. Unclamped Energy Test Circuit

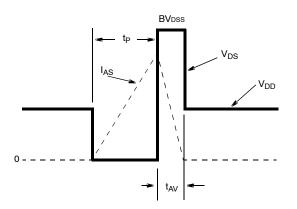


Figure 12. Unclamped Energy Waveforms

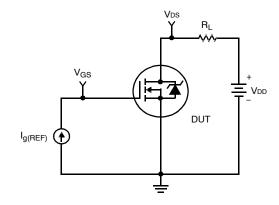


Figure 13. Gate Charge Test Circuit

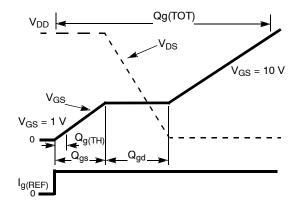


Figure 14. Gate Charge Waveforms

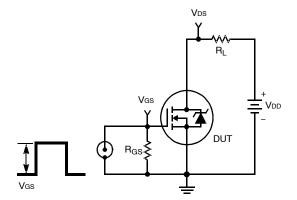


Figure 15. Switching Time Test Circuit

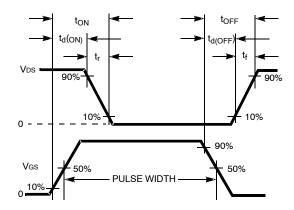
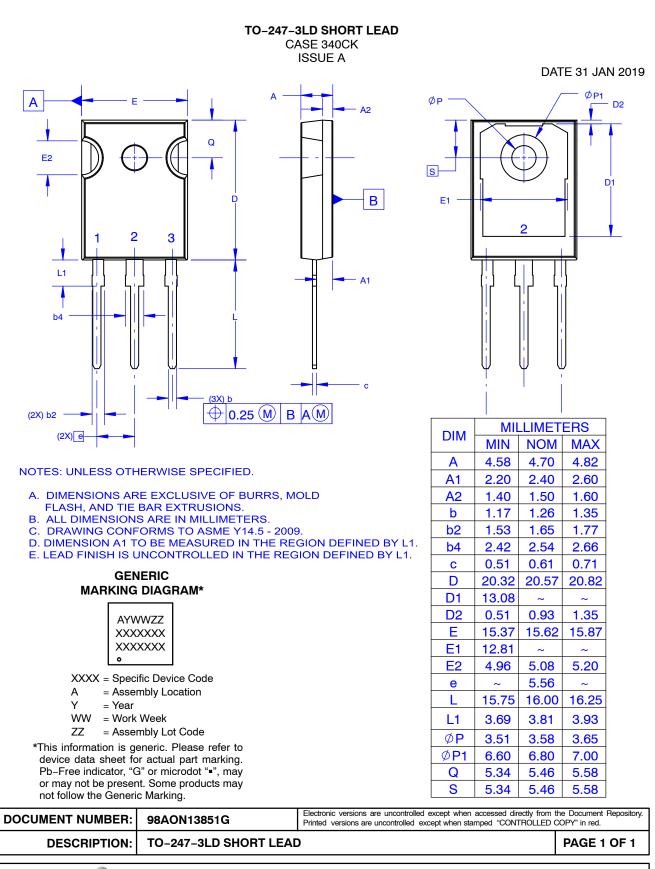


Figure 16. Switching Time Waveform

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